

11/13/01



J1060 U.S. PTO

PATENT APPLICATION

Assistant Commissioner for Patents
 Box Patent Application
 Washington, D. C. 20231

J1011 U.S. PTO
09/993240

10/13/11

Sir:

Enclosed herewith for filing is the following utility
 patent application:

Applicants: Padmapani C. Nallan, Ajay Kumar

Title of application: APPARATUS FOR CONTROLLING A THERMAL
 CONDUCTIVITY PROFILE FOR A PEDESTAL IN
 A SEMICONDUCTOR WAFER PROCESSING
 CHAMBER

Pages of specification: 10 (including 3 pages of claims and
 1 page of abstract)

Sheets of drawing: 3 (informal)

Executed on: 11-13-01 Docket No.: 6493/ETCH/SILICON

PATENT APPLICATION FILING FEE CALCULATION

	No. Filed	Less	Rate/Claim	Fee
Total Claims	21	-20	1 x \$18.00	<u>\$18.00</u>
Independent Claims	4	-3	1 x \$84.00	<u>\$84.00</u>
Minimum Filing Fee				\$740.00
Multiple Dependency Fee (if applicable - \$270.00)				\$_____
50% Reduction for Small Entity (Independent Inventor, Non-profit Corporation, or Small Business Concern) - appropriate verified statement attached				- \$_____

TOTAL FILING FEE **\$842.00**

Kindly charge the entire and/or any additional filing fee, as appropriate, to deposit account number 50-1074. To facilitate that charge, a duplicate copy of this letter is enclosed herewith.

[illegible]

Also enclosed herewith for filing in connection with the enclosed application are:

Filing date

Respectfully submitted,

EL865963464US

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